

2023 Fourth Quarter Operating Result

Photoresist Materials Division: The Layout of Electronic Materials Business group in ASEAN



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Date: 2024/03/15







- 1. Profile
- 2. 2023 Fourth Quarter Operating Result
- 3. Introduction to Electronic Materials Business Group
- 4. The Layout of Electronic Materials Business Group in ASEAN



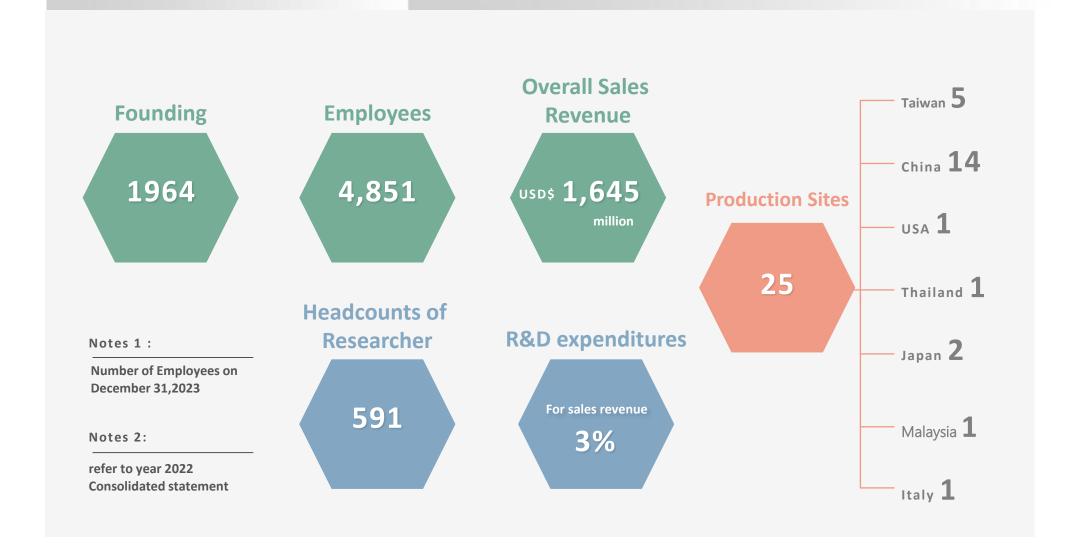


Profile



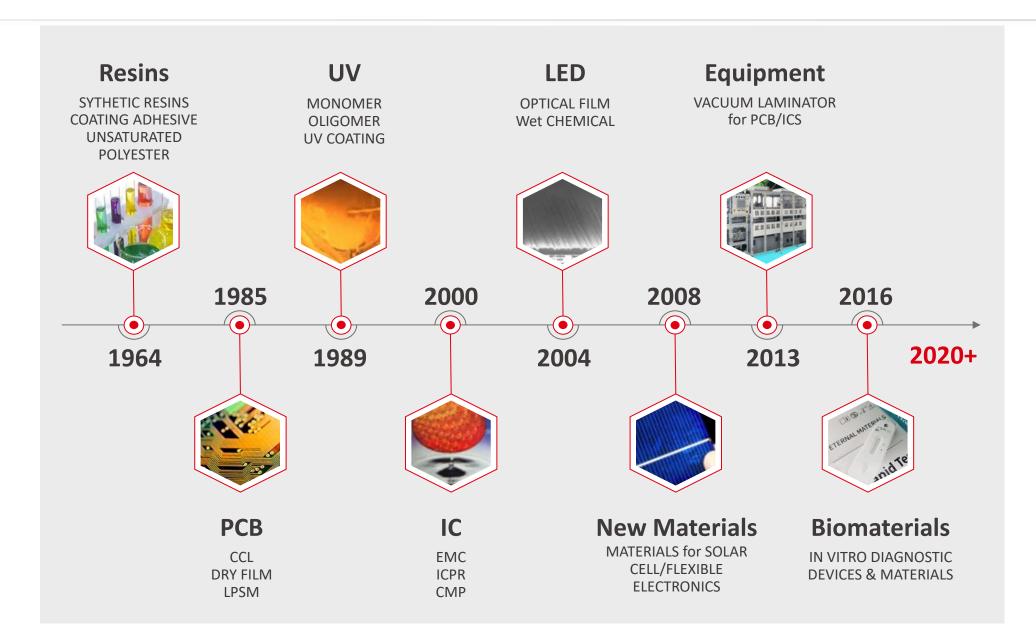


Core Business — Manufacturing, processing and sales



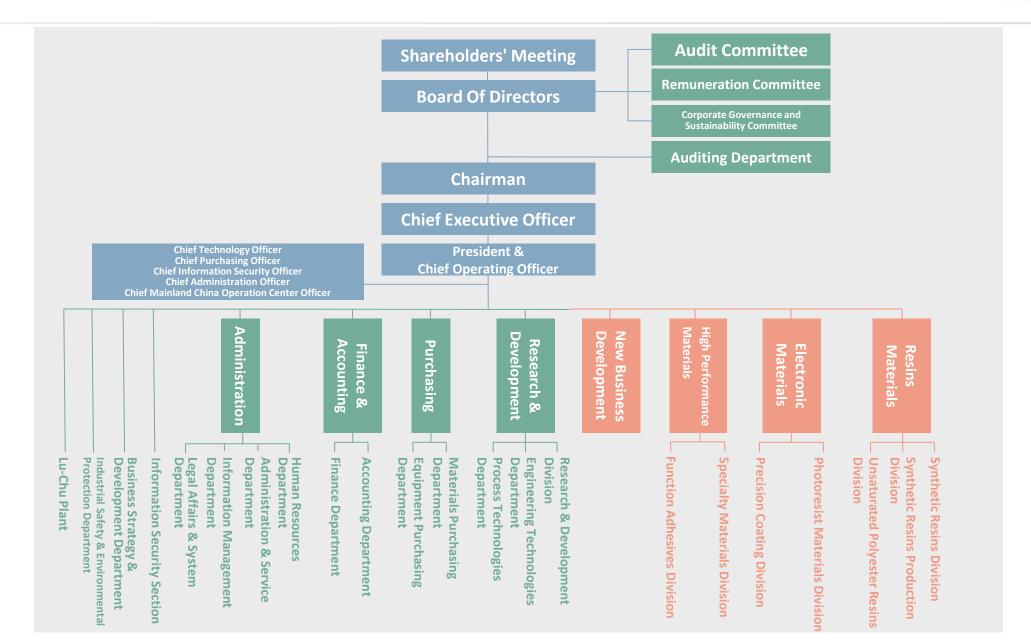
Development Milestones





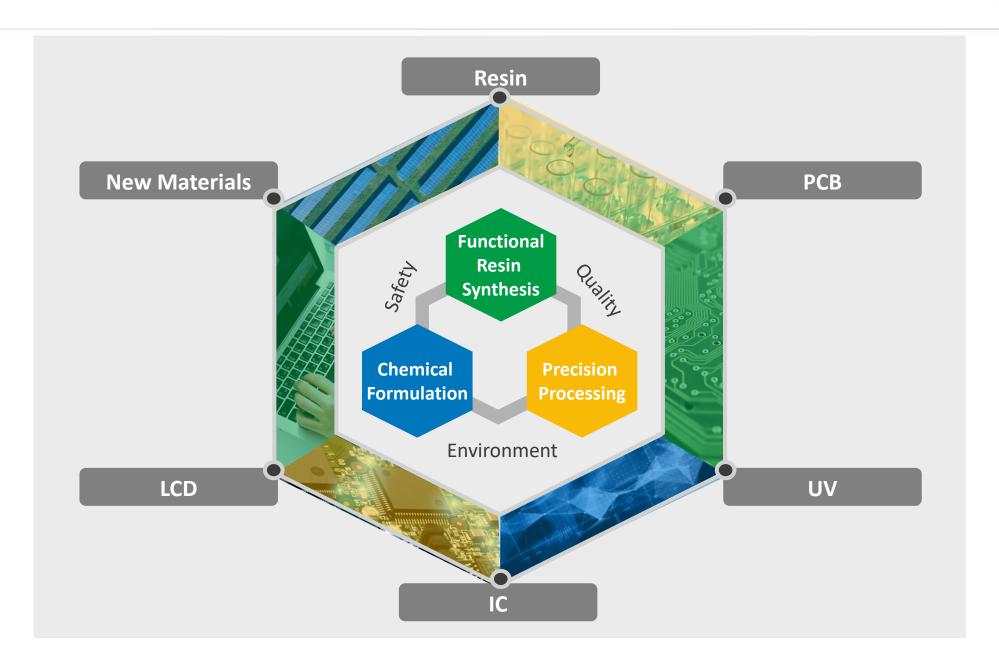
Organization





Core Technology





New Development



Biomaterials

- Diagnostic Enzymes for Molecular Biology
- Diagnostic Enzymes for **Biochemistry of Blood**
- Dengue Virus-related **Monoclonal Antibodies**
- Biomedical Diagnostic materials

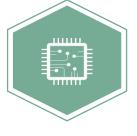


Flexible electronics materials

- Dry Film Solder Mask
- Polyimide; PI
- Photosensitive polyimide
- PSPI

Advanced packing materials

- Liquid Epoxy Molding Compound
- Underfill





High performance resin materials

- Organic-inorganic hybrid materials
- Fluorocarbon polymer
- Nano-structured polymer
- Liquid crystal polymer
- High performance thermoplastic composites



Development

Functionality Improvement



Green energy/energy storage materials

- Wind power materials
- Solar cell materials
- Lithium battery materials
- Conductive polymer

Environmental protection idea product

- Water-based resins
- UV curable resins
- Lead/halogen/chromium-free materials
- Biomass /recycle materials

Global Production Sites





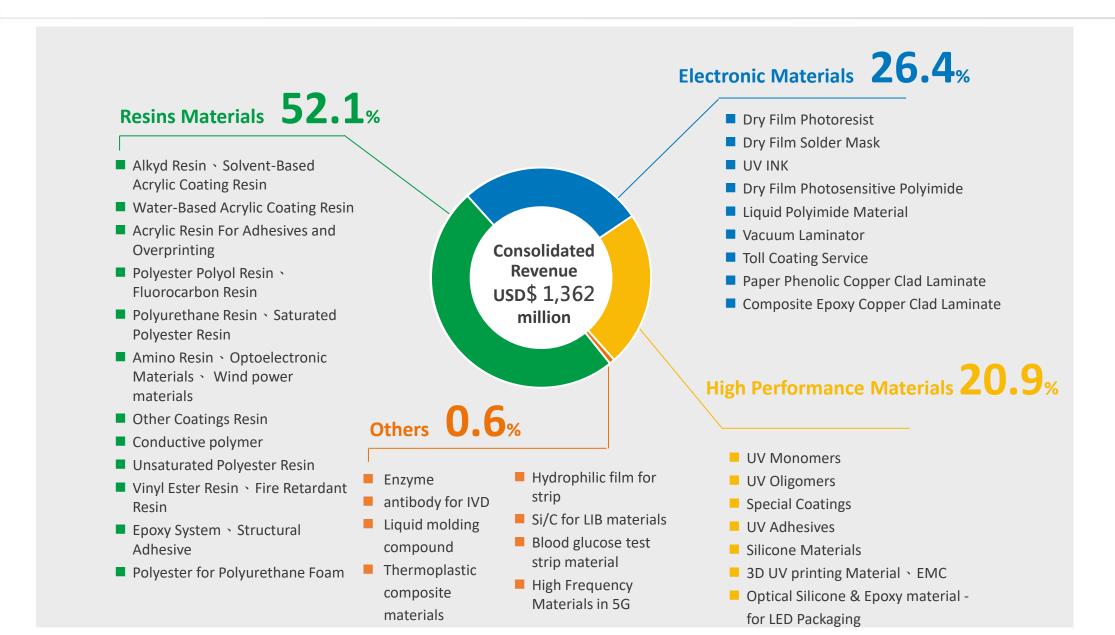
Global Service Network





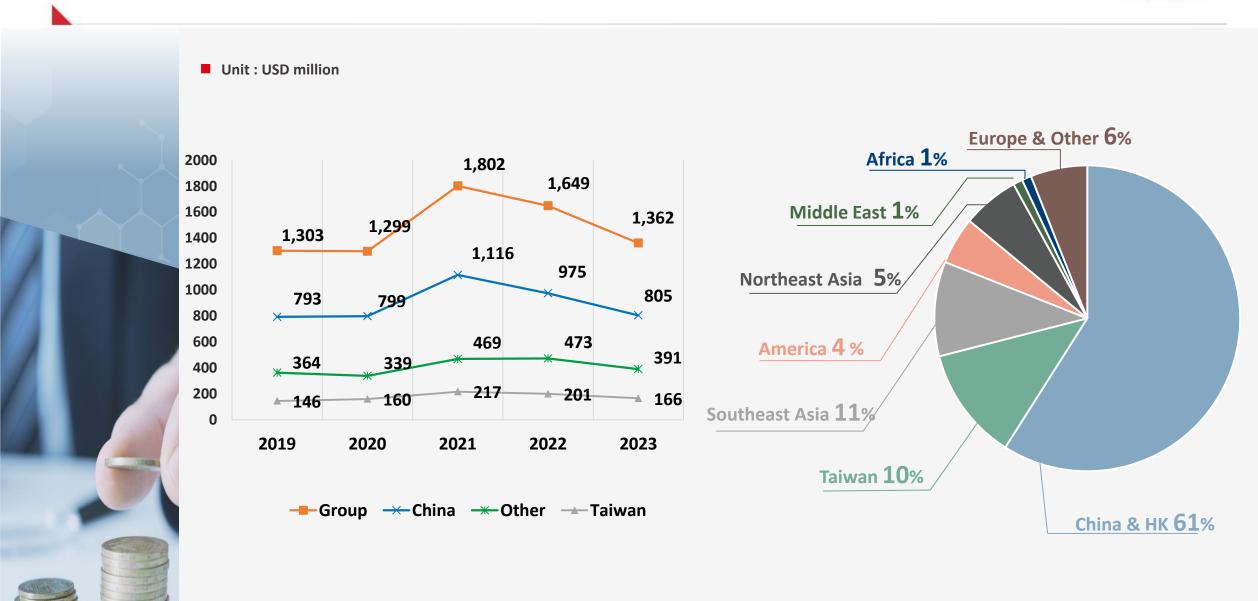
2023 Product Lines Sales Ratio





Annual Sales Distribution (In the recent 5 years), 2023 Regional Markets Sales Ratio











Financial Information-Balance Sheets & Key Indices



	2023		2022		2021		Unit : TW
	Amount	%	Amount	%	Amount	%	
Cash and cash equivalents and current financial assets	7,624	<u>13</u>	6,671	<u>11</u>	4,444	<u>7</u>	
Accounts receivable	15,213	<u>26</u>	17,132	<u>29</u>	20,071	<u>33</u>	
Inventories	8,479	<u>14</u>	9,716	<u>16</u>	10,678	<u>18</u>	
Financial assets	3,516	<u>6</u>	3,155	<u>5</u>	3,506	<u>6</u>	
Property, plant and equipment	18,323	<u>31</u>	17,473	<u>29</u>	16,369	<u>27</u>	
otal Assets	58,538	<u>100</u>	59,455	<u>100</u>	60,536	<u>100</u>	
Short-term borrowings	5,557	<u>9</u>	5,364	<u>9</u>	4,588	<u>8</u>	
Current portion of long-term borrowings	3,741	<u>6</u>	3,040	<u>5</u>	4,326	<u>7</u>	
Long-term borrowings	11,858	<u>20</u>	13,988	<u>24</u>	12,506	<u>21</u>	
otal Liabilities	33,322	<u>57</u>	34,384	<u>58</u>	35,869	<u>59</u>	
otal Equity	25,216	<u>43</u>	25,071	<u>42</u>	24,667	<u>41</u>	
Key Financial Ratios							
Average cash collection days	141	L	141	L	138		
Average days required for sale	99		98		85		
Current ratio (%)	182	2	206	5	190		

Financial Information-Statements of Comprehensive Income



	2023		2022	2022		2021	
	Amount	%	Amount	%	Amount	%	
Operating Revenue	42,452	100	49,014	100	50,471	100	
Gross profit	8,147	19	10,163	21	10,694	21	
Operating expenses	(6,232)	(15)	(6,886)	(14)	(6,599)	(13)	
Operating Income	1,915	5	3,277	7	4,095	8	
Non-operating income and expenses	268	1	238	0	337	1	
Net profit attributable to owners of the company	1,504		2,618		3,549		
Key Financial Ratios							
Net profit margin (%)	4		5		7		
EPS	1.28		2.15		2.86		
ROE (%)	6		11		14		

Financial Information-Cash Flow Statements



Unit: TWD Millions

	2023	2022	2021	
	Amount	Amount	Amount	
Cash and cash equivalents at the beginning of the year	5,451	4,289	6,108	
Cash flows from operating activities	6,514	6,581	750	
Acquisition of property, plant and equipment	(3,149)	(2,783)	(2,049)	
Increase (decrease) in borrowings	(1,107)	681	1,743	
Dividends paid	(1,414)	(1,860)	(1,860)	
Other items	250	(1,568)	(216)	
Effects of exchange rate changes on cash and cash equivalents	(163)	110	(187)	
Cash and cash equivalents at the end of the period	6,382	5,451	4,289	
Free cash flow	3,365	3,799	(1,299)	

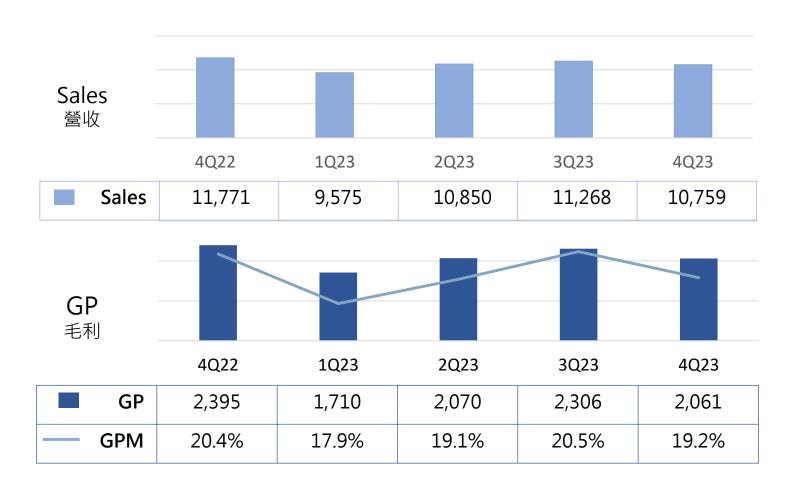
Note: Free cash flow=

Cash flows from operating activities - Acquisition of property, plant and equipment

Sales Revenues & Gross Profits



Unit: TWD Millions

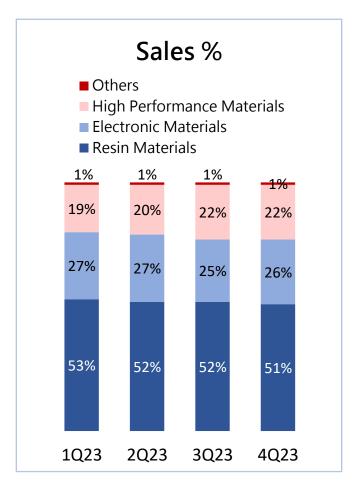


4Q23	у/у	q/q
Sales	-8.6%	-4.5%
Gross Profits	-13.9%	-10.6%

Performance by Segment



TWD Millions	4Q Sales			4Q Operating Profits		
		y/y	q/q		y/y	q/q
Resin Materials	5,542	-4%	-6%	97	+6%	-56%
Electronic Materials	2,824	-23%	-1%	169	-59%	-28%
High Performance Materials	2,336	+5%	-5%	338	+27%	-19%







- Introduction to Electronic Materials Business Group
- The Layout of Electronic Materials Business group in ASEAN

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Introduction to Electronic Materials Business Group





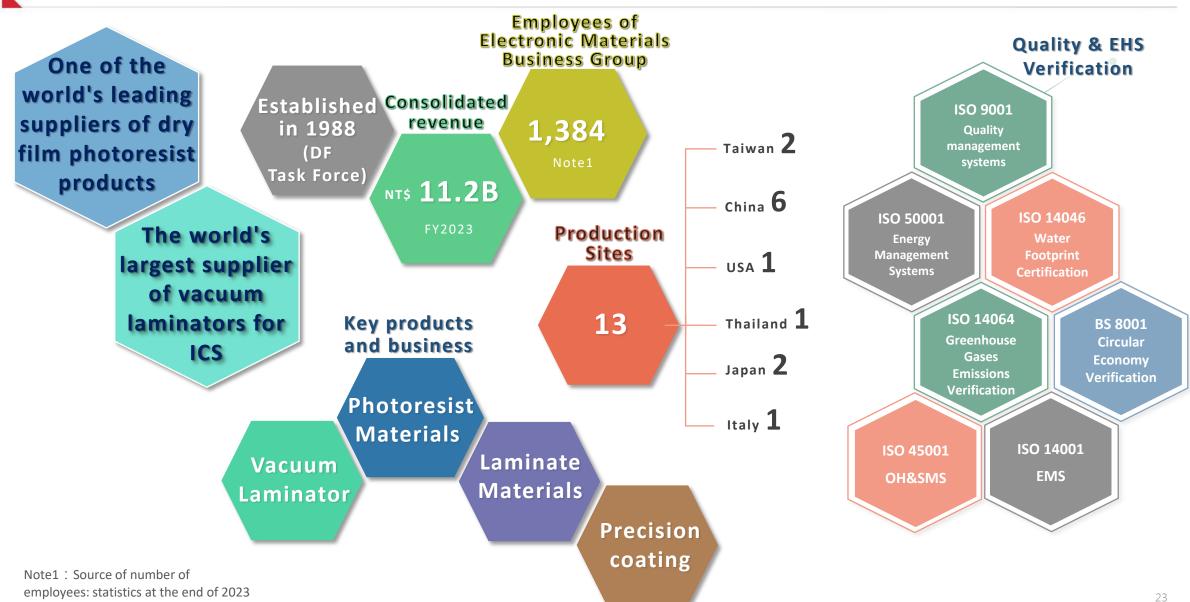




- 1. Electronic Materials Business Group Profile
- 2. Important Milestones in Business Development
- 3. Revenue (2019~2023)
- 4. Key Products and Applications

Electronic Materials Business Group Profile





Important Milestones in Business Development

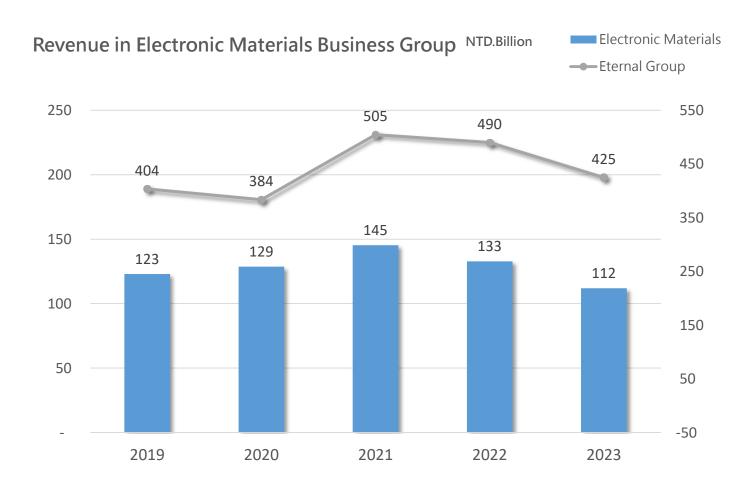
To be continued...



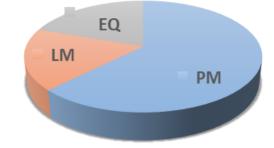
1	1990 1990	Taiwan Ta-Fa Plant was established and started producing dry film photoresist
	1995 1995	Established Eternal Chemical (China) Co., Ltd. Guangzhou (Southern China Slitting Plant)
	1999 1999	Established Eternal Technology Corporation (ETC) and Eternal Photo Electronic Materials (Kunshan) Co., Ltd. (Eastern Chin Slitting Plant)
	2001 2001	Established Eternal Photo Electronic Materials (Guangzhou) Co., Ltd. (Southern China Plant 1)
	2003 2003	US ETC acquires Shipley Company, L.L.C. Dry Film product line
	2006 2006	Established Eternal Photo Electronic Materials (Guangzhou) Co., Ltd. (Southern China Plant 2)
	2007 2007	Established Eternal Photoelectric Material Industry (Yingkou) Co., Ltd.
	2008 2008	Established Eternal Electronic Material (Thailand) Co., Ltd.
	2012 2012	Established Eternal Photo Electronic Materials (Guangzhou) Co., Ltd. Chongqing Branch
	2013 2013	Acquired 100% equity of Nichigo-Morton Co., Ltd. (NM Nikko Materials) & acquired 60% equity of Elga Europe S.r.l.
	2013 2013	Established Eternal Electronic (Suzhou) Co., Ltd. (Eastern China Plant 1)
	2017 2017	Acquired the vacuum laminating machine production business of Nikko Materials OEM
	2017 2017	Acquisition of 35% stake in Elga Europe S.r.l.
	2022 2022	Established Eternal Precision Machinery Co., Ltd.
	2023 2023	Established Hubei Slitting Plant
	2023 2023	Established Eternal Precision Machinery (Guangzhou) Co., Ltd.
,		

Consolidated Revenue in Electronic Materials Business Group (2019~2023)





Electronic Materials Products Revenue Proportion



Source: Annual Report of Eternal Materials

Key Products and Applications



Key Produc	ct	Illustrate	Applications	
Dry Film Photoresist		Dry film photoresist is the key component used in the image transfer process. It is widely used in precision etching and electroplating products such as Printed Circuit Board (including Rigid board, Flexible board, Rigid/Flexible composite board, and HDI), Lead Frame, IC Substrates, IC packaging, etc.	IT, communications, automobiles, semiconductors, consumer electronics and other products	
Dry Film Solder Mask (DFSM)		It is mainly used for circuit protection (Solder Mask) of precision outer layers of flexible/rigid PCB, IC Substrate, high-precision metal substrates/ceramic substrates/glass substrates, etc. It is a permanent material.	IT, communications, automobiles, semiconductors, consumer electronics and other products	
Photo-Imageable- Coverlay (PIC)	0000	Low-temperature 150°C baking type, high-precision weak alkaline dry film photoresist, used for high-precision flexible printed circuit board (FPC)/metal substrate outer circuit protection	IT, communications, automobiles, semiconductors, consumer electronics and other products	
Paper Phenolic Copper Clad Laminate (FR-1)		Copper clad paper phenolic laminate is made of bleached kraft paper impregnated with phenolic resin and then hot press with copper foil to form an insulating material. It is suitable for punching and drilling process.	Home appliances, information peripherals, communications, power supplies and other related electronic products	
Composite Epoxy Copper Clad Laminate (CEM-1)		It is composed of two base materials: fiberglass fabric and bleached kraft paper core material. The product is mainly a single-sided copper foil substrate and is suitable for punching and drilling process.	Home appliances, information peripherals, communications, power supplies and other related electronic products	

Key Products and Applications



Key Prod	uct	Illustrate	Applications	
Liquid UV Curable Marking Ink		The screen printing process is used for text and graphic markings on double-sided and multi-layer printed circuit boards. It is suitable for printing text and graphic markings on double-sided and multi-layer printed circuit boards. The ink has excellent adhesion and heat resistance after hardening.	IT, communications, automobiles, semiconductors, consumer electronics and other products	
Liquid Polyimide Material		Touch sensor substrate and flexible electronic substrate, dielectric layer material of probe card	Displays and touch panels, Wafer Test Probe Card	
Toll Coating Service	Clana	With continuous cumulate of coating technique and experience, which allowed us to cooperate with the customers by providing high value coating products, as well as precision toll coating services.	LCD/TP Industry, PV Backsheet, IC Sub Build-up Filmetc.	
Vacuum Laminator		Diaphragm-type vacuum laminator provides excellent conformation of various build-up materials to fine patterns and via holes. In addition, the high-precision hot press unit provides uniform thickness and surface flatness.	The related application processes of IC packaging substrates, FPC, NCF and LED	



The Layout of Electronic Materials Business group in ASEAN







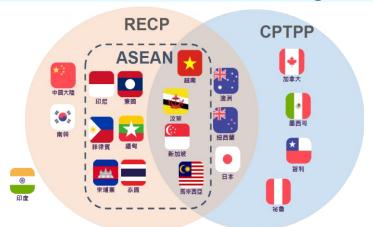


- 1. Geopolitical Risks
- 2. ASEAN PCB Industry Development Trends
- 3. Key Products of the ASEAN PCB Industry
- 4. Global Layout of Electronic Materials Business group
- 5. Industrial Distribution of PCB and Layout of Electronic Materials Business Group in ASEAN
- 6. Conclusion

Geopolitical Risks



- In response to the impact of the Sino-US trade war, as well as the rise in inflation and raw materials caused by the conflict between Ukraine and Russia, the industrial supply chain is facing restructuring.
- China+1 aims to decrease reliance on manufacturing in China, secure access to critical and strategic materials, and reducing business operational risks, hence many companies have raised attention to investing in ASEAN.
- The manufacturing industry has moved out of China and dispersed to emerging countries such as ASEAN and India. Overseas investment will focus on being close to customers and industrial clusters.
- To cope with geopolitical uncertainty, it's crucial for enterprises to adjust strategic planning, reducing and diversifying the risk of production with resilience and good adaptability.
- These ten ASEAN countries has the third largest population in the world which amount to 670 million, and their GDP reaches US\$3.6 trillion, making them the third largest in Asia.
- ASEAN itself is both a manufacturing factory and a huge consumer market.



ASEAN
actively participates in
global economic
integration



ASEAN PCB Industry Development Trends

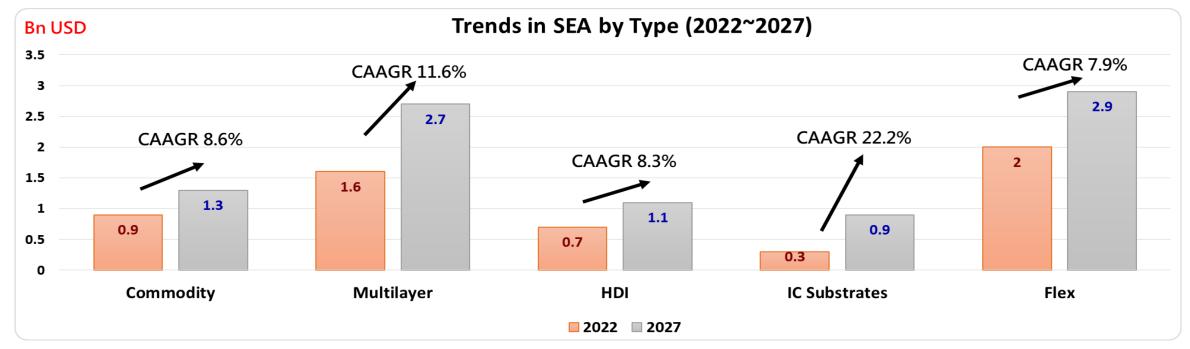


According to Prismark Estimates, ASEAN PCB Industry Trends (By Type):

CAAGR Growth Forecast: IC Substrates > Multilayer > Commodity > HDI > Flex

Production Value Estimate: Flex > Multilayer > Commodity > HDI > IC Substrates

ASEAN PCB Industry Trends (By Type)



Key Products of the ASEAN PCB Industry



ASEAN is the main growth area for the PCB industry, The main applications are FPC (Vietnam applied to Smartphone), Multilayer (Thailand applied to server and automotive), IC Substrates (Malaysia applied to CPU, GPU) and High-Density Multilayer HDI PCB, expected demand growing up very fast in the coming years.

ITEM	SS/DS	ML	HDI	IC Substrate	FPC
Product			FCCE		
Structure					
Application	Consumer, LED, Power-Supply System	PC, NB, Server, EV, Automotive, Industrial PC, Work Station	Smart phone, PC, NB, HPC, MotherBoard, EV, Automotive	Smart Phone, Module, NB, CPU, GPU, Base Station, Automotive EV, AI	EV, Automotive, LED Lamp, Antenna, SIM Card, Mobile Device, Camera Module, Antenna Module
CAAGR 2022 ~ 2027Y	8.6%	11.6%	8.3%	22.2%	7.9%

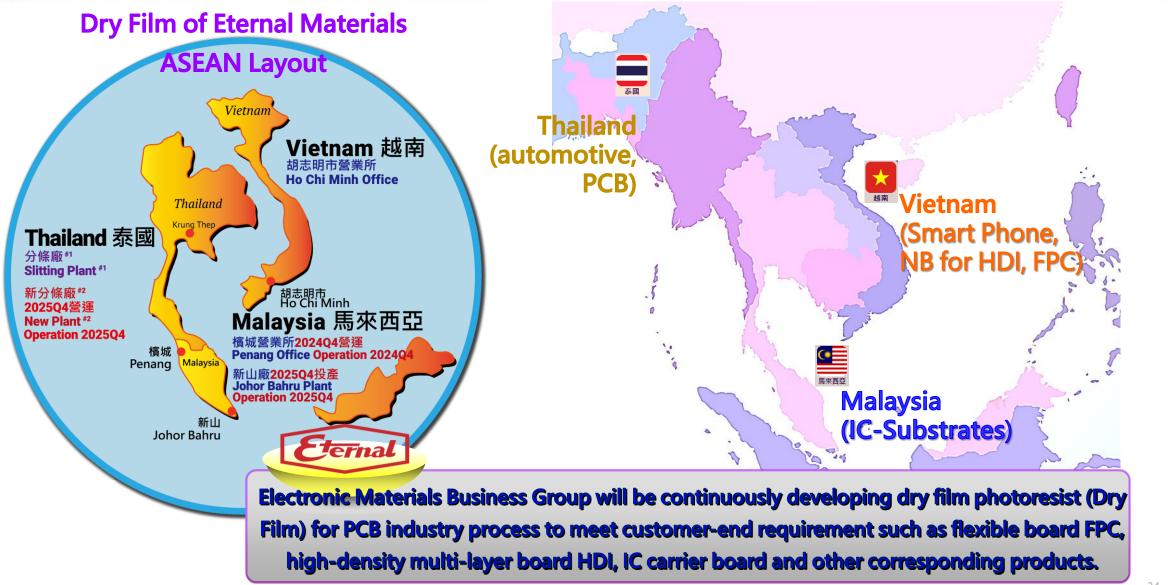
Global Layout of Electronic Materials Business group





Industrial Distribution of PCB and Layout of Electronic Materials Business Group in ASEAN Feed





Conclusion



1

The Sino-US trade war and the conflict between Ukraine and Russia have caused the price of raw materials to rise. In response to the reorganization of industrial supply chains due to geopolitical risks, the trend of companies investing in ASEAN has increased significantly. ASEAN itself is both a manufacturing factory and a huge consumer market.

2

The main applications for ASEAN PCB growth are FPC, Multilayer, and IC Substrates, HDI PCB, expected to be used in ASEAN PCB industry process in 2024, the annual demand for dry film photoresist (Dry Film) market is 1.1 million KSF.



5

ETERNAL Group is deeply involved in ASEAN, providing local supply and professional application technical teams to provide customers with flexible and timely sales services. The Electronic Materials Business Group is expected to expand and increase slitting capacity and shipping warehouse, and plan to build Dry Film coating factory in Malaysia in 2025 Operation 2025Q4 to meet the demand for dry film photoresist (Dry Film) in the ASEAN market.

